



**ECN/PCN No.: 4139**

For Manufacturer			
<b>Product Description:</b> PLASTIC SMD MEMS OSCILLATOR	<b>Abracon Part Number / Part Series:</b> EMRA36	<input type="checkbox"/> Documentation only <input type="checkbox"/> ECN <input checked="" type="checkbox"/> EOL	<input checked="" type="checkbox"/> Series <input type="checkbox"/> Part Number
<b>Affected Revision:</b> A	<b>New Revision:</b> EOL	<b>Application:</b>	<input type="checkbox"/> Safety <input checked="" type="checkbox"/> Non-Safety
<b>Prior to Change:</b> Active <a href="https://abracon.com/datasheets/Ecliptek/EMRA36.pdf">https://abracon.com/datasheets/Ecliptek/EMRA36.pdf</a>			
<b>After Change:</b> EOL			
<b>Cause/Reason for Change:</b> Discontinuation of manufacturing capability.			
Change Plan			
<b>Effective Date:</b> 2/7/2022	<b>Additional Remarks:</b> N/A		
<b>Change Declaration:</b> N/A			
<b>Issued Date:</b> 2/7/2022	<b>Issued By:</b> <i>Brooke Cushman</i> Product Engineer	<b>Issued Department:</b> Engineering	
<b>Approval:</b> <i>Thomas Culhane</i> Engineering Director	<b>Approval:</b> <i>Reuben Quintanilla</i> Quality Director	<b>Approval:</b> <i>Ying Huang</i> Purchasing Director	
For Abracon EOL only			
<b>Last Time Buy (if applicable):</b> 5/7/2022	<b>Alternate Part Number / Part Series:</b> ASEDV (3.2x2.5mm)		
<b>Additional Approval:</b>	<b>Additional Approval:</b>	<b>Additional Approval:</b>	
Customer Approval (If Applicable)			
<b>Qualification Status:</b> <input type="checkbox"/> Approved <input type="checkbox"/> Not accepted <i>Note: It is considered approved if there is no feedback from the customer 1 month after ECN/PCN is released.</i>			
<b>Customer Part Number:</b>		<b>Customer Project:</b>	
<b>Company Name:</b>	<b>Company Representative:</b>	<b>Representative Signature:</b>	
<b>Customer Remarks:</b>			

## REGULATORY COMPLIANCE

Lead Free



COMPLIANT

EU RoHS

2011/65 +  
2015/863

COMPLIANT

China RoHS



COMPLIANT

REACH

SVHC

COMPLIANT



## ITEM DESCRIPTION

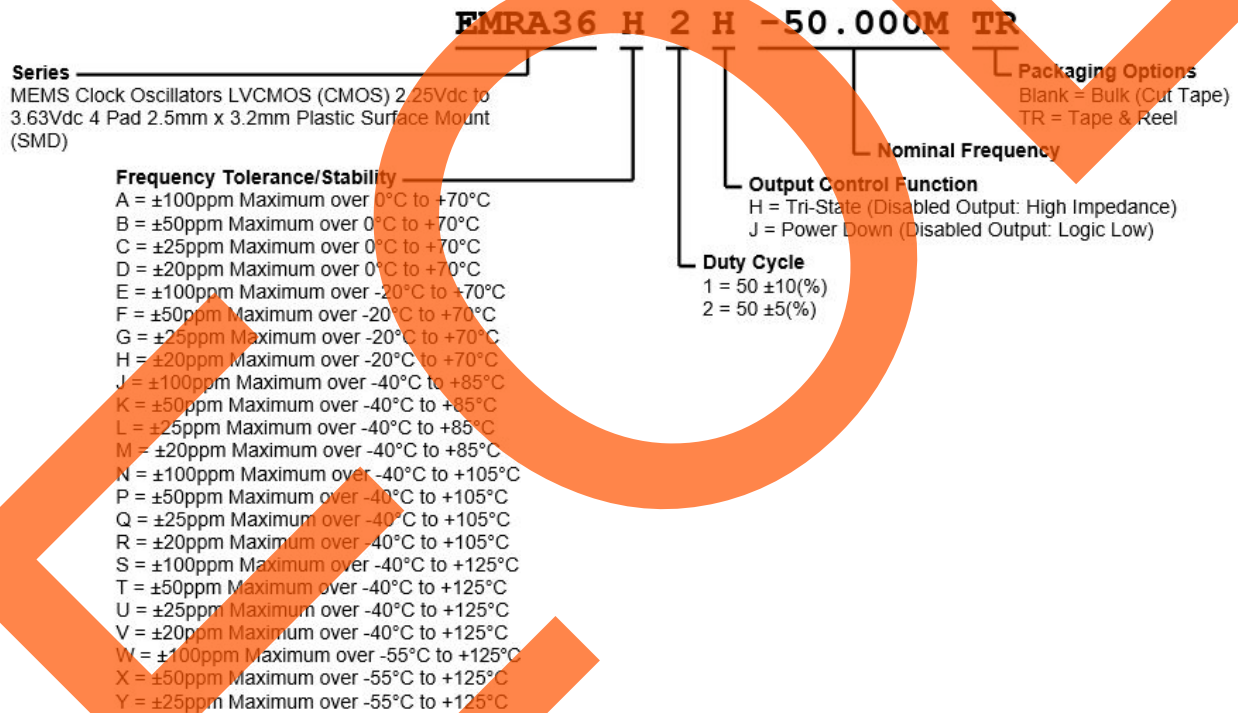
MEMS Clock Oscillators LVCMOS (CMOS) 2.25Vdc to 3.63Vdc 4 Pad 2.5mm x 3.2mm Plastic Surface Mount (SMD)

## ELECTRICAL SPECIFICATIONS

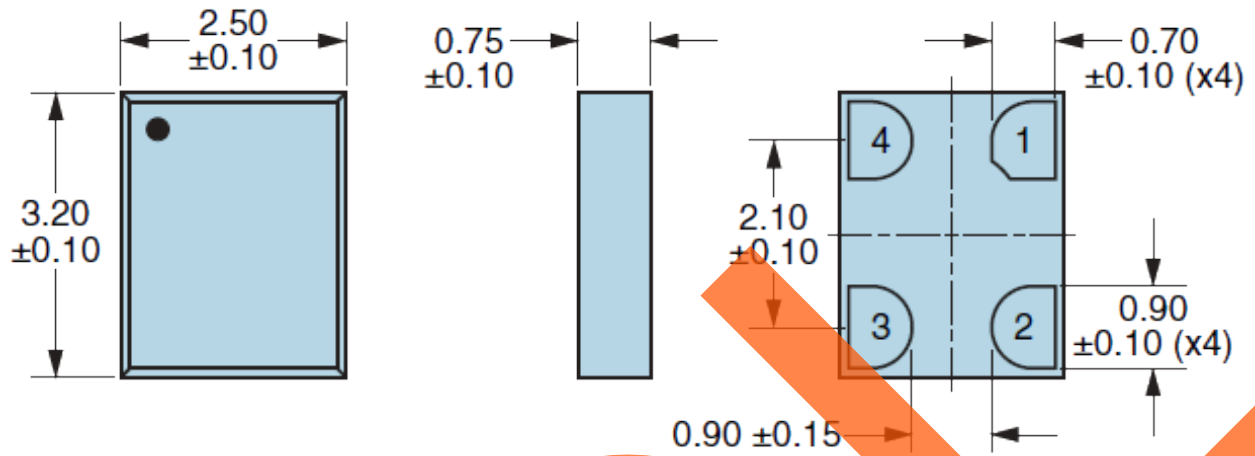
Nominal Frequency	1MHz to 137MHz
Frequency Tolerance/Stability	Inclusive of all conditions: Calibration Tolerance at 25°C, Frequency Stability over the Operating Temperature Range, Supply Voltage Change, Output Load Change, and First Year Aging at 25°C ±100ppm Maximum over 0°C to +70°C ±50ppm Maximum over 0°C to +70°C ±25ppm Maximum over 0°C to +70°C ±20ppm Maximum over 0°C to +70°C ±100ppm Maximum over -20°C to +70°C ±50ppm Maximum over -20°C to +70°C ±25ppm Maximum over -20°C to +70°C ±20ppm Maximum over -20°C to +70°C ±100ppm Maximum over -40°C to +85°C ±50ppm Maximum over -40°C to +85°C ±25ppm Maximum over -40°C to +85°C ±20ppm Maximum over -40°C to +85°C ±100ppm Maximum over -40°C to +105°C ±50ppm Maximum over -40°C to +105°C ±25ppm Maximum over -40°C to +105°C ±20ppm Maximum over -40°C to +105°C ±100ppm Maximum over -40°C to +125°C ±50ppm Maximum over -40°C to +125°C ±25ppm Maximum over -40°C to +125°C ±20ppm Maximum over -40°C to +125°C ±100ppm Maximum over -55°C to +125°C ±50ppm Maximum over -55°C to +125°C ±25ppm Maximum over -55°C to +125°C
Aging at 25°C	±1.5ppm Maximum First Year
Supply Voltage	2.25Vdc to 3.63Vdc
Input Current	No Load 5mA Maximum over Nominal Frequency of 1MHz to 20MHz 6mA Maximum over Nominal Frequency of 20.000001MHz to 50MHz 7mA Maximum over Nominal Frequency of 50.000001MHz to 80MHz 9mA Maximum over Nominal Frequency of 80.000001MHz to 137MHz
Output Voltage Logic High (V <sub>OH</sub> )	IOH = -4mA 90% of Vdd Minimum
Output Voltage Logic Low (V <sub>OL</sub> )	IOL = +4mA 10% of Vdd Maximum
Rise/Fall Time	Measured from 20% to 80% of waveform 1.2nSec Typical, 3nSec Maximum
Duty Cycle	Measured at 50% of waveform 50 ±10(%) 50 ±5(%)
Load Drive Capability	15pF Maximum
Output Logic Type	CMOS
Output Control Function	Tri-State (Disabled Output: High Impedance) Power Down (Disabled Output: Logic Low)
Output Control Input Voltage Logic High (V <sub>IH</sub> )	70% of Vdd Minimum or No Connect to Enable Output

Output Control Input Voltage Logic Low (Vil)	30% of Vdd Maximum to Disable Output
Power Down Output Enable Time	5mSec Maximum (Disabled Output: Logic Low)
Tri-State Output Enable Time	150nSec Maximum (Disabled Output: High Impedance)
Power Down Output Disable Time	150nSec Maximum (Disabled Output: Logic Low)
Tri-State Output Disable Time	150nSec Maximum (Disabled Output: High Impedance)
Standby Current	5µA Maximum (Disabled Output: Logic Low)
Period Jitter (RMS)	2pSec Typical, 4pSec Maximum
RMS Phase Jitter (Fj = 900kHz to 7.5MHz; Random)	0.5pSec Typical, 1pSec Maximum
RMS Phase Jitter (Fj = 12kHz to 20MHz; Random)	1.5pSec Typical, 3pSec Maximum
Start Up Time	5mSec Maximum
Storage Temperature Range	-65°C to +150°C

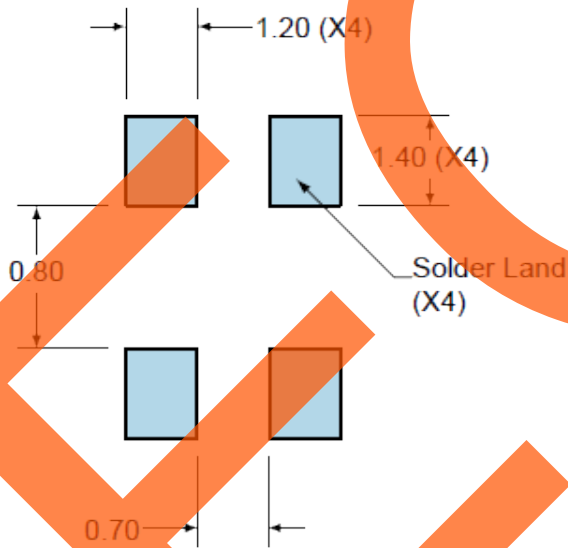
## PART NUMBERING GUIDE



MECHANICAL DIMENSIONS



SUGGESTED SOLDER PAD LAYOUT

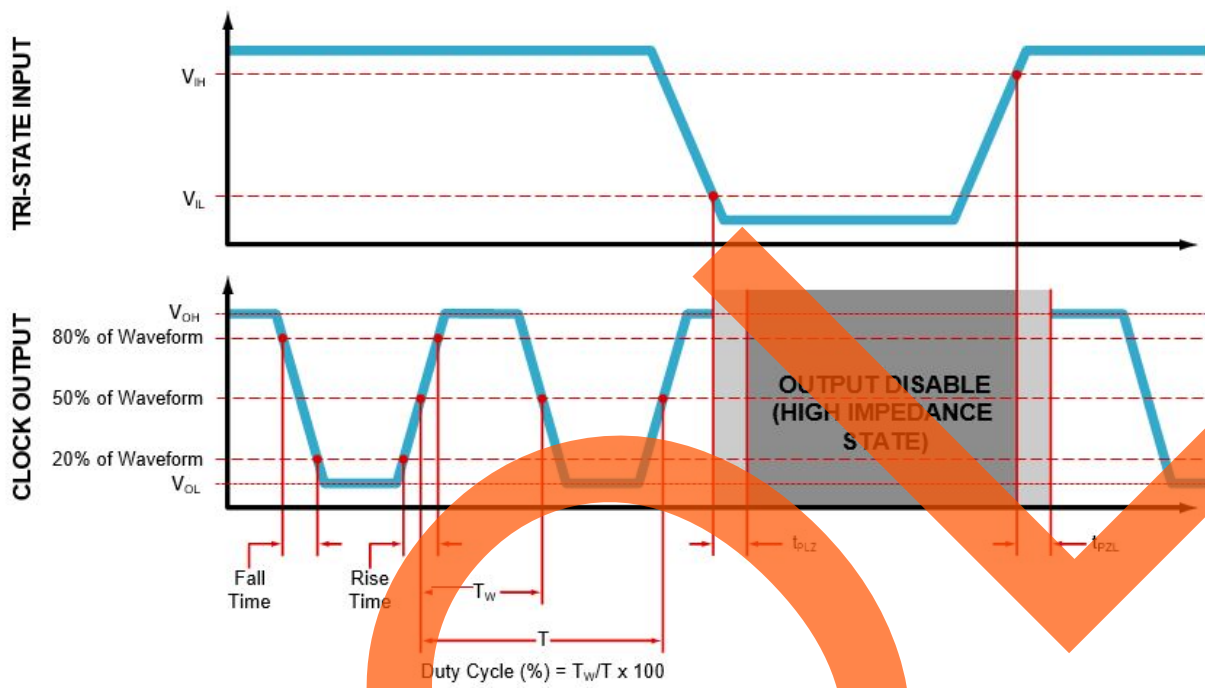


PIN	CONNECTION
1	Power Down Or Tri-State
2	Ground
3	Output
4	Supply Voltage

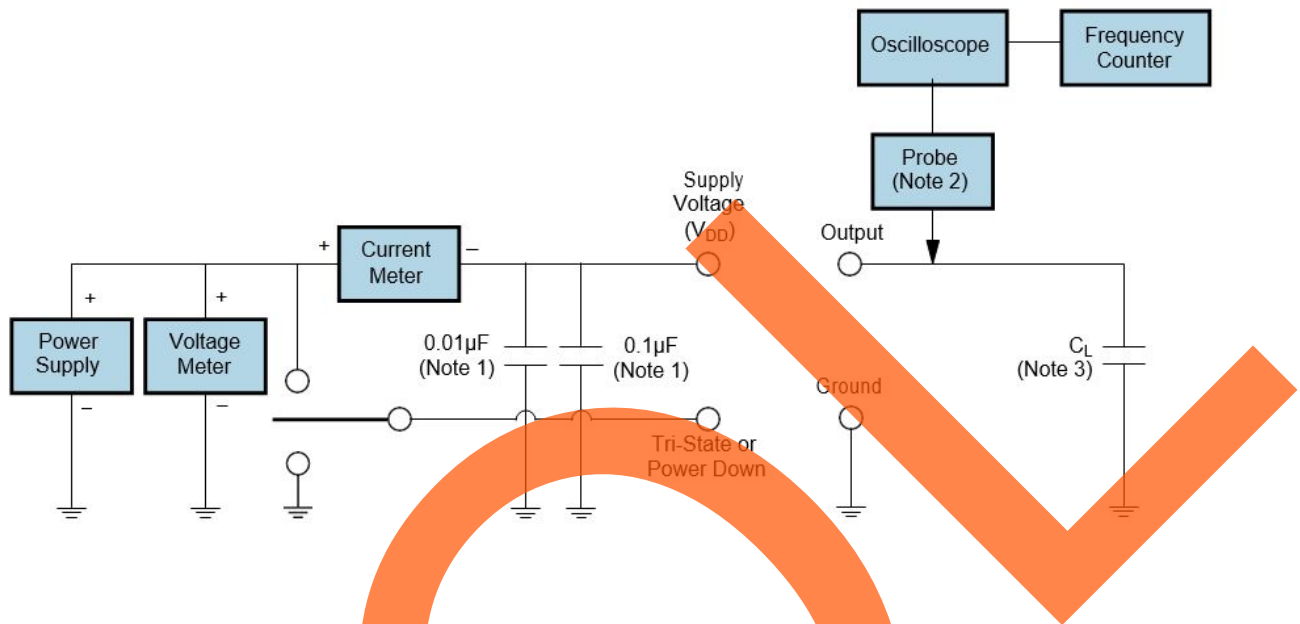
All Tolerances are  $\pm 0.1$

All Dimensions in Millimeters

OUTPUT WAVEFORM & TIMING DIAGRAM



## TEST CIRCUIT FOR CMOS OUTPUT



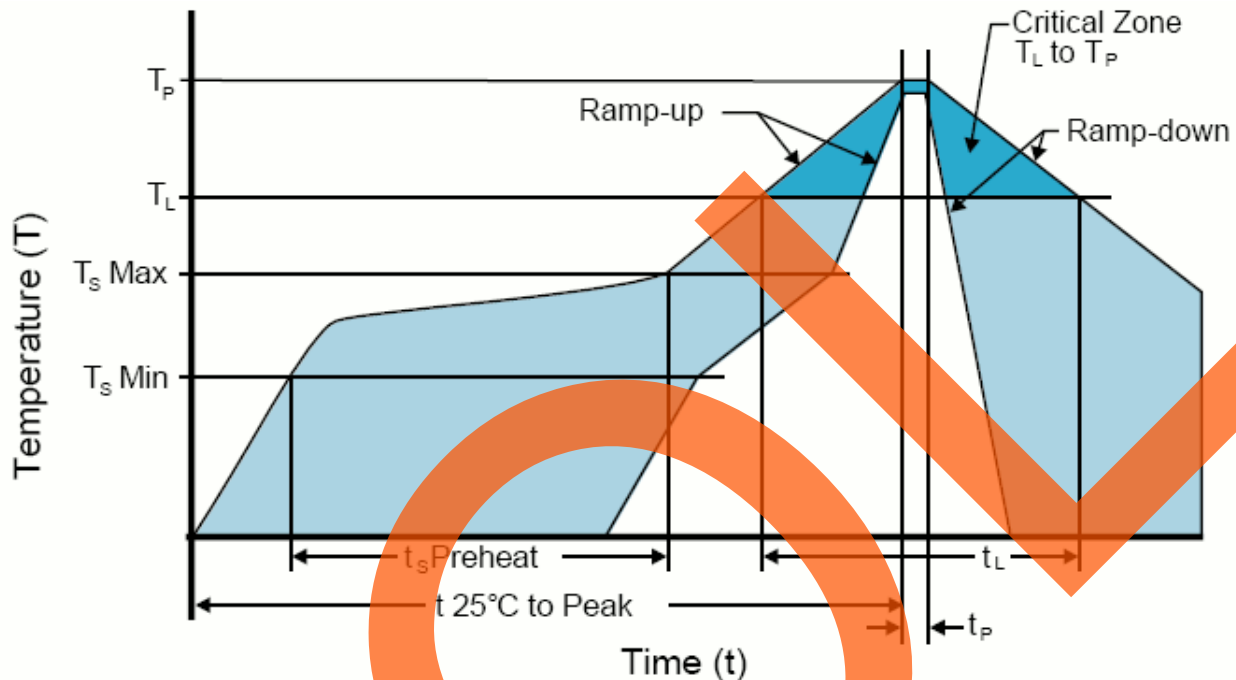
**Note 1:** An external 0.01µF ceramic bypass capacitor in parallel with a 0.1µF high frequency ceramic bypass capacitor close (less than 2mm) to the package ground and supply voltage pin is required.

**Note 2:** A low input capacitance (<12pF), 10X Attenuation Factor, High Impedance (>10Mohms), and High bandwidth (>300MHz) Passive probe is recommended.

**Note 3:** Capacitance value  $C_L$  includes sum of all probe and fixture capacitance. See applicable specification sheet for 'Load Drive Capability'.



RECOMMENDED SOLDER REFLOW METHOD



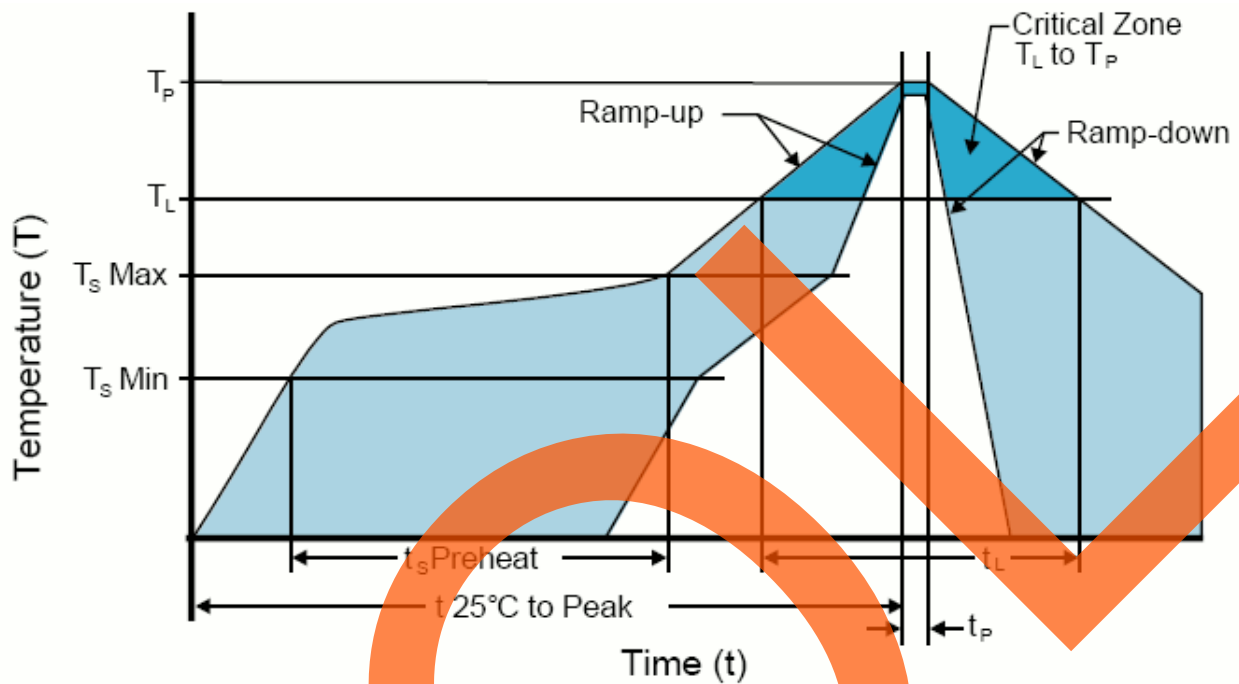
**HIGH TEMPERATURE INFRARED/CONVECTION**

T <sub>S</sub> MAX to T <sub>L</sub> (Ramp-up Rate)	3°C/Second Maximum
<b>Preheat</b>	
- Temperature Minimum (T <sub>S</sub> MIN)	150°C
- Temperature Typical (T <sub>S</sub> TYP)	175°C
- Temperature Maximum (T <sub>S</sub> MAX)	200°C
- Time (t <sub>S</sub> MIN)	60 - 180 Seconds
<b>Ramp-up Rate (T<sub>L</sub> to T<sub>P</sub>)</b>	3°C/Second Maximum
<b>Time Maintained Above:</b>	
- Temperature (T <sub>L</sub> )	217°C
- Time (t <sub>L</sub> )	60 - 150 Seconds
<b>Peak Temperature (T<sub>P</sub>)</b>	260°C Maximum for 10 Seconds Maximum
<b>Target Peak Temperature (T<sub>P</sub> Target)</b>	250°C +0/-5°C
<b>Time within 5°C of actual peak (t<sub>p</sub>)</b>	20 - 40 Seconds
<b>Ramp-down Rate</b>	6°C/Second Maximum
<b>Time 25°C to Peak Temperature (t)</b>	8 Minutes Maximum
<b>Moisture Sensitivity Level</b>	Level 1
<b>Additional Notes</b>	Temperatures shown are applied to body of device.

**High Temperature Manual Soldering**

260°C Maximum for 5 Seconds Maximum, 2 times Maximum. (Temperatures shown are applied to body of device.)

RECOMMENDED SOLDER REFLOW METHOD



**LOW TEMPERATURE INFRARED/CONVECTION**

<b><math>T_S \text{ MAX to } T_L</math> (Ramp-up Rate)</b>	5°C/Second Maximum
<b>Preheat</b>	
- Temperature Minimum ( $T_S \text{ MIN}$ )	N/A
- Temperature Typical ( $T_S \text{ TYP}$ )	150°C
- Temperature Maximum ( $T_S \text{ MAX}$ )	N/A
- Time ( $t_s \text{ MIN}$ )	60 - 120 Seconds
<b>Ramp-up Rate (<math>T_L</math> to <math>T_P</math>)</b>	5°C/Second Maximum
<b>Time Maintained Above:</b>	
- Temperature ( $T_L$ )	150°C
- Time ( $t_L$ )	200 Seconds Maximum
<b>Peak Temperature (<math>T_P</math>)</b>	240°C Maximum
<b>Target Peak Temperature (<math>T_P \text{ Target}</math>)</b>	240°C Maximum 2 Times / 230°C Maximum 1 Time
<b>Time within 5°C of actual peak (<math>t_P</math>)</b>	10 Seconds Maximum 2 Times / 80 Seconds Maximum 1 Time
<b>Ramp-down Rate</b>	5°C/Second Maximum
<b>Time 25°C to Peak Temperature (t)</b>	N/A
<b>Moisture Sensitivity Level</b>	Level 1
<b>Additional Notes</b>	Temperatures shown are applied to body of device.

**Low Temperature Manual Soldering**

185°C Maximum for 10 Seconds Maximum, 2 times Maximum. (Temperatures shown are applied to body of device.)

## Looking for pricing, stock, or lifecycle information?

Click below to explore more details on WIN SOURCE:

- ⊖ [View EMRA36M2H-25.000M on WIN SOURCE](#)
- ⊖ [Ecliptek Corporation Information](#)

## Optimize Your Supply Chain with WIN SOURCE Solutions

- ✓ Global Sourcing Solution
- ✓ Obsolete Management
- ✓ Cost Control Management
- ✓ Shortage Management
- ✓ Alternative Solution
- ✓ Excess Inventory Management